

MIC2551A

USB Transceiver

General Description

The MIC2551A is a single chip transceiver that complies with the physical layer specifications of the Universal Serial Bus (USB) 2.0. It supports both full speed (12Mbps) and low speed (1.5Mbps) operation and introduces superior edge rate control, producing crisper eye diagrams, which ease the task of passing USB compliance testing.

A unique, patented, dual supply voltage operation allows the MIC2551A to reference the system I/F I/O signals to a supply voltage down to 1.6V while independently powered by the USB V_{BUS} . This allows the system interface to operate at its core voltage without addition of buffering logic and also reduce system operating current.

Features

- Compliant to USB Specification Revision 2.0 for full speed (12Mbs) and low speed (1.5Mbps) operation
- Compliant to IEC-61000-4.2 (Level 3)
- Separate I/O supply with operation down to 1.6V
- Integrated speed select termination supply
- Very-low power consumption to meet USB suspendcurrent requirements
- Small TSSOP and MLF[®] packages
- No power supply sequencing requirements
- Software controlled re-enumeration

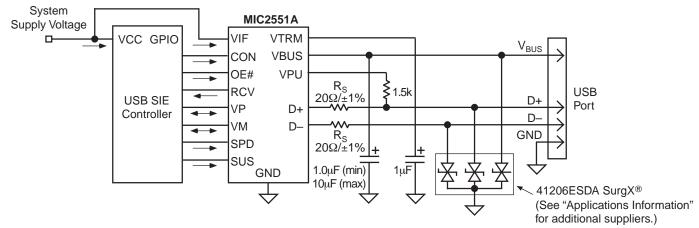
Applications

- PDAs
- Palmtops
- Cell phones

Ordering Information

| Part Nur | | |
|-------------|-------------|-------------------------|
| Standard | Pb-Free | Package |
| MIC2551ABTS | MIC2551AYTS | 14-Pin TSSOP |
| MIC2551ABML | MIC2551AYML | 16-Pin MLF [®] |

Typical Application

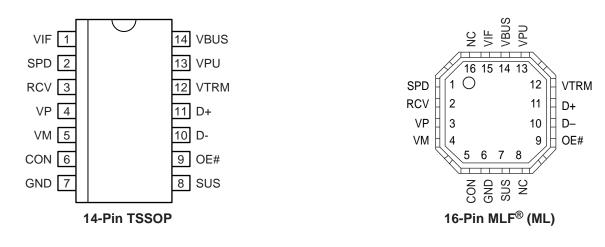


Typical Application Circuit

*Micro*LeadFrame and MLF are registered trademarks of Amkor Technology. SurgX is a registered trademark of Cooper Electronics Technologies.

Micrel, Inc. • 2180 Fortune Drive • San Jose, CA 95131 • USA • tel + 1 (408) 944-0800 • fax + 1 (408) 474-1000 • http://www.micrel.com

Pin Configuration



Pin Description

| Pin Number MIC2551ABTS | Pin Number MIC2551ABML | Pin Name | I/O | Pin Function |
|---------------------------|---------------------------|----------|-----|--|
| 1 | 15 | VIF | I | System Interface Supply Voltage: Used to provide reference supply voltage for system I/O interface signaling. |
| 2 | 1 | SPD | I | Edge Rate Control: A logic HIGH operates at edge rates for "full speed" operation. A logic LOW operates edge rates for "low speed" operation. |
| 3 | 2 | RCV* | 0 | Receive Data: Output for USB differential data. |
| 4 | 3 | VP* | I/O | If OE# = 1, VP = Receiver output (+) If OE# = 0, VP = Driver input (+) |
| 5 | 4 | VM* | I/O | If OE# = 1 VM, = Receiver output (-) If OE# = 0, VM = Driver input (-) |
| 6 | 5 | CON | I | CONNECT (Input): Controls state of VPU. Refer to VPU pin description for detail. |
| 7 | 6 | GND | | Ground Reference. |
| 8 | 7 | SUS | I | Suspend: Active-High. Turns off internal circuits to reduce supply current. |
| 9 | 9 | OE#* | I | Output Enable: Active-Low. Enables the transceiver to transmit data onto the bus. When inactive, the transceiver is in the receive mode. |
| 10/11 | 10/11 | D–, D+* | I/O | Differential data lines conforming to the USB standard. |
| 12 | 12 | VTRM | 0 | 3.3V Reference Supply Output: Requires a minimum 0.1 μ F decoupling capacitor for stability. A 1 μ F capacitor is recommended |
| 13 | 13 | VPU | 0 | Pull-up Supply Voltage Output: Used to connect $1.5k\Omega$ pull-up speed detect resistor. If CON = 1, VPU is high impedance. If CON = 0, VPU = 3.3V. |
| 14 | 14 | VBUS | I | USB Bus Supply Voltage: Used to power USB transceiver and internal circuitry. |
| | 8,16 | NC | | No connect. |

* See Table 1 for description of logic states.

| SUS | OE# | D+, D- | RCV | VP/VM | Function |
|-----|-----|-----------|--------|------------|--|
| 0 | 0 | Driving | Active | Active | Normal transmit mode. |
| 0 | 1 | Receiving | Active | Active | Normal receive mode. |
| 1 | 0 | Hi-Z | 0 | Not active | Low power state. |
| 1 | 1 | Hi-Z | 0 | Active | Receiving during suspend (low power state) (Note 1). |

Note 1. During suspend VP and VM are active in order to detect out-of-band signaling conditions.

Table 1. Function Selection

| OE# = 0: | | | | | | | |
|----------|-------|----|--------|-----|-----------|--|--|
| Ir | Input | | Output | | | | |
| VP | VM | D+ | D- | RCV | - Result | | |
| 0 | 0 | 0 | 0 | X | SE0 | | |
| 0 | 1 | 0 | 1 | 0 | Logic 0 | | |
| 1 | 0 | 1 | 0 | 1 | Logic 1 | | |
| 1 | 1 | 1 | 1 | X | Undefined | | |
| OE# = 1: | | | | | | | |
| Ir | nput | | Output | | Desult | | |
| D+ | D- | VP | VM | RCV | Result | | |
| 0 | 0 | 0 | 0 | X | SE0 | | |
| 0 | 1 | 0 | 1 | 0 | Logic 0 | | |
| 1 | 0 | 1 | 0 | 1 | Logic 1 | | |
| 1 | 1 | 1 | 1 | X | Undefined | | |

X - Undefined

Table 2. Truth Table During Normal Mode

| Supply Voltage (V _{BUS}) | |
|------------------------------------|-----------------|
| All Other Inputs | –0.5V to 5.5V |
| Ambient Storage Temperature | –65°C to +150°C |
| Output Current (D+, D–) | ± 50mA |
| Output Current (all others) | ±15mA |
| Input Current | ±50mA |
| ESD, Note 3 | |
| V _{BUS} , D+, D– | ±11KV |
| All other pins | ±2KV |

| operating ratings (note 2) | |
|---|------------|
| Supply Voltage (V _{BUS}) 4.0\ | √ to 5.25V |
| Ambient Operating Temperature40°0 | C to +85°C |
| Package Thermal Resistance | |
| TSSOP (θ _{.IA}) | 100(°C/W) |
| $MLF^{\otimes}(\theta_{JA})$ | . 59(°C/W) |
| | |

DC Electrical Characteristics (System and USB Interface) (Note 7)

 V_{IF} = 3.6V, V_{BUS} = 5V unless otherwise noted; T_A = 25°C. **Bold** indicates specifications over temperature, -40°C to 85°C.

| Symbol | Parameter | | | Conditions | | | Min | Тур | Мах | Units |
|------------------------------------|---------------------------------|-----------------|----------|--|----------------------------|---|---------------------|---------------------|----------------------|-------|
| V _{BUS} | USB Supply Voltage | | | | | | 4.0 | | 5.25 | V |
| V _{IF} | System I/F Supply Volta | age | | | | | 1.6 | | 3.6 | V |
| V _{IL} | LOW-Level Input Voltage, Note 4 | | | | | V _{IF} 0.3 | | 0.15V _{IF} | V | |
| V _{IH} | HIGH-Level Input Voltage | ge, Note | 94 | | | | 0.85V _{IF} | | V _{IF} +0.3 | V |
| V _{OH} | HIGH-Level Output Volt | age, No | ote 4 | I _{OH} = 2 | 0μΑ | | 0.9V _{IF} | | | V |
| V _{OL} | LOW-Level Output Volta | age, No | te 4 | $I_{OL} = 20\mu A$ | | | | | 0.1 | V |
| | Input Leakage Current, | Note 4 | | 01 | | | -5 | | 5 | μA |
| Symbol | Parameter | | I | | Conditions | | Min | Тур | Max | Units |
| | | SPD | SUS | OE# | Voltage | Load | | | | |
| | | 1 | 0 | 1 | | | | 1 | 5 | μA |
| | | 1 | 0 | 0 | | | | 1 | 5 | μA |
| IIF | | 0 | 0 | 1 | | | | 1 | 5 | μΑ |
| | VIF Supply Current | 0 | 0 | 0 | VBUS = 5.25V VIF = 3.6V | | | 1 | 5 | μΑ |
| | | 0 | 1 | 0 | | | | 1 | 5 | μΑ |
| | | 1 | 0 | 0 | | f = 6MHz CLOAD = 50 pF, Note 7 | | 325 | 650 | μΑ |
| | | 0 | 0 | 0 | | f = 750kHz CLOAD = 600 pF Note 7 | | 40 | 75 | μΑ |
| | | 1 | 0 | 1 | | | | 800 | 1100 | μA |
| | | 1 | 0 | 0 | | | | 3000 | 5000 | μA |
| | | 0 | 0 | 1 | | | | 230 | 350 | μA |
| | | 0 | 0 | 0 | | | | 400 | 700 | μA |
| I _{VBUS} | VBUS Supply Current | 0 | 1 | 0 | VBUS = 5.25V | | | 130 | 200 | μΑ |
| | | 1 | 0 | 0 | VIF = 3.6V | f = 6MHz CLOAD = 50 pF, Note 7 | | 7.3 | 10 | mA |
| | | 0 | 0 | 0 | | f = 750kHz CLOAD = 600 pF Note 7 | | 3.6 | 5 | mA |
| IVPULEAK | VPU Leakage Current | | <u> </u> | CON = 1, V _{PU} = 0V | | -5 | | 5 | μA | |
| IVIFLEAK | VIF Leakage Current | | | V _{IF} = 3 | .6V, V _{BUS} = 0V | | -5 | | 5 | μA |
| V _{PU} | Pull-Up Output Voltage | | | I _{TERM} = 200μA, V _{BUS} = 4.0 to 5.25V | | 3.0 | 3.3 | 3.6 | V | |
| R _{SW} | Internal Pull-Up Termination | | | I _{TERM} = 10mA, V _{BUS} = 4.0 to 5.25V | | | | 10 | | Ω |
| ESD Protect | ion | | | | | | | | | |
| IEC-1000-4-2 | | | Τ | 10 puls | es | | | ±8 | | kV |
| (D+, D–, V _{BUS} only) | Contact Discharge | | | 10 puls | | | | ±9 | | kV |

DC Electrical Characteristics (Transceiver) (Note 7)

| Symbol | Parameter | Conditions | Min | Тур | Max | Units |
|--------------------------------------|--|---|-----|---------|--------|-------|
| Leakage C | urrent | | • | | • | |
| I _{LO} | Hi-Z State Data Line Leakage (Suspend Mode) | 0V < V _{IN} < 3.3V, SUS = 1 | -10 | | 10 | μΑ |
| Input Leve | ls | | - | | | |
| V _{DI} | Differential Input Sensitivity | (D+) - (D-) | 0.2 | | | V |
| V _{CM} | Differential Common Mode Range | Includes V _{DI} range | 0.8 | | 2.5 | V |
| V _{SE} | Single-Ended Receiver Threshold | | 0.8 | | 2.0 | V |
| | Receiver Hysteresis | | | 200 | | mV |
| Output Lev | vels | | | | - | |
| V _{OL} | Static Output Low | $R_L = 1.5 k\Omega$ to 3.6V | | | 0.3 | V |
| V _{OH} | Static Output High | $R_L = 15k\Omega$ to GND | 2.8 | | 3.6 | V |
| Capacitand | ce . | | • | | • | |
| C _{IN} | Transceiver Capacitance | Pin to GND | | 10 | | pF |
| Z _{DRV} | Driver Output Resistance | Steady state drive | 8 | 16 | 24 | Ω |
| | ctrical Characteristics (Notes | s 6, 7) | | | • | |
| Driver Cha | racteristics (Low Speed) | | | | | |
| T _R | Transition Rise Time | $C_L = 50$ pF, Figure 2 $C_L = 600$ pF | 75 | | 300 | ns |
| Τ _F | Transition Fall Time | $C_L = 50$ pF, Figure 2 $C_L = 600$ pF | 75 | | 300 | ns |
| T _R , T _F | Rise/Fall Time Matching | (T _R , T _F) | 80 | | 125 | % |
| V _{CRS} | Output Signal Crossover Voltage | | 1.3 | | 2.0 | V |
| Driver Cha | racteristics (Full Speed) | | • | | • | |
| T _R | Transition Rise Time | C _L = 50pF, Figure 2 | 4 | | 20 | ns |
| T _F | Transition Fall Time | C _L = 50pF, Figure 2 | 4 | | 20 | ns |
| T _R , T _F | Rise/Fall Time Matching | (T _R , T _F) | 90 | | 111.11 | % |
| V _{CRS} | Output Signal Crossover Voltage | | 1.3 | | 2.0 | V |
| Transceive | r Timing | | • | | • | |
| t _{PVZ} | OE# to RCVR Tri-State Delay | Figure 1 | | | 15 | ns |
| t _{PZD} | Receiver Tri-State to Transmit Delay | Figure 1 | 15 | | | ns |
| t _{PDZ} | OE# to DRVR Tri-State Delay | Figure 1 | | | 15 | ns |
| t _{PZV} | Driver Tri-State to Receive Delay | Figure 1 | 15 | | | ns |
| t _{PLH} t _{PHL} | VP, VM to D+, D– Propagation Delay | Figure 4 | | | 15 | ns |
| t _{PLH} t _{PHL} | D+, D- to RCV Propagation Delay | Figure 3 | | | 15 | ns |
| t _{PLH} t _{PHL} | D+, D– to V_P , V_M Propagation Delay | Figure 3 | | | 8 | ns |

Note 1. Exceeding the absolute maximum rating may damage the device.

Note 2. The device is not guaranteed to function outside its operating rating.

Note 3. Devices are ESD sensitive. Handling precautions recommended. Human body model, 1.5k in series with 100pF.

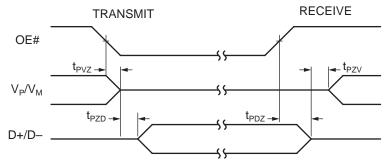
Note 4. Specification applies to the following pins: SUS, SPD, RCV, CON, RCV, VP, VM, OE#.

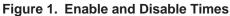
Note 5. Characterized specification(s), but not production tested.

Note 6. All AC parameters guaranteed by design but not production tested.

Note 7. Specification for packaged product only.

Timing Diagrams





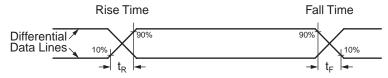


Figure 2. Rise and Fall Times

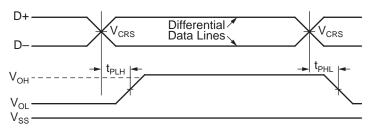


Figure 3. Receiver Propagation Delay

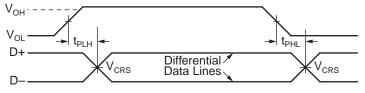


Figure 4. Driver Propagation Delay

Test Circuits

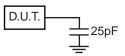


Figure 5. Load for V_P , V_M , RCV

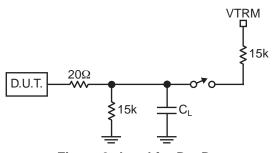
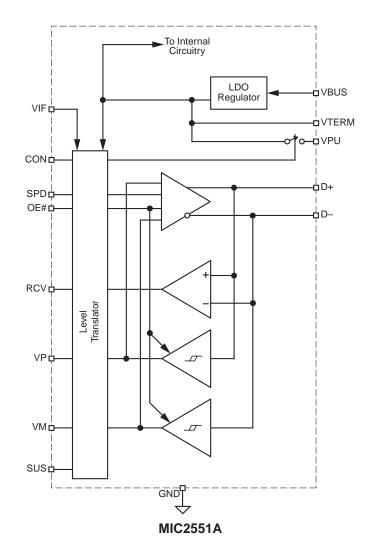


Figure 6. Load for D+, D-

Functional Diagram



Applications Information

The MIC2551A is designed to provide USB connectivity in mobile systems where available system supply voltages are not able to satisfy USB requirements. The MIC2551A can operate down to supply voltages of 1.6V and still meet USB physical layer specifications. As shown in the circuit above, the MIC2551A takes advantage of the USB supply voltage, V_{BUS} , to operate the transceiver. The system voltage, V_{IF} , is used to set the reference voltage used by the digital I/O lines interfacing to the system controller. Internal circuitry provides translation between the USB and system voltage domains. V_{IF} will typically be the main supply voltage rail for the controller.

In addition, a 3.3V, 10% termination supply voltage, (V_{PU}), is provided to support speed selection. V_{PU} can be disabled or enabled under software control via the CON input. This allows for software-controlled connect or disconnect states. A 1.5k resistor is required to be connected between this pin and the D+ or D– lines to respectively specify high speed or low speed operation.

The use of ESD transient protection devices is not required for operation, but is recommended. The MIC2551A is ESD rated for 11kV at the VBUS and D+, D– pins and 2kV for all other pins. MIC2551A

Power Supply Configuration

The MIC2551A can be set up for different power supply configurations which modify the behavior of the device. Both V_{BUS} and V_{IF} have special thresholds that detect when they are either removed or grounded. Table 3 depicts the behavior under the different power supply configuration scenarios that are explained below.

Normal Mode

 $\rm V_{BUS}$ is connected to the 5.0V USB bus voltage and $\rm V_{IF}$ is connected to a supply voltage in the range of 1.6V to 3.6V. In this case $\rm V_{TRM}$ supplies a 3.3V voltage for powering the speed select resistor via $\rm V_{PU}$ depending on the state of CON pin.

Disconnect Mode

 $V_{\rm IF}$ is connected to a supply in a range of 1.6V to 3.6V and $V_{\rm BUS}$ is open or grounded. If $V_{\rm BUS}$ is opened while transmitting, the data lines (D+, D–) have sharing capability and may be driven with external devices up to approximately 3.6V if and only if SUSPEND is enabled (SUS = 1). With $V_{\rm BUS}$ ground, D+, D– sharing mode is not permitted.

Disable Mode

 $\rm V_{BUS}$ is connected to the 5.0V USB bus voltage and $\rm V_{IF}$ is open. All logic controlled inputs become high impedances, thus minimal current will be supplied by $\rm V_{IF}$ if the input pins are pulled up to an external source.

Alternate Power Supply Configuration Options

I/O Interface Using 3.3V

In systems where the I/O interface utilizes a 3.3V USB controller, an alternate solution is shown in Figure 7. No extra components are required; however, the load on $\rm V_{TRM}$ must not exceed 10mA.

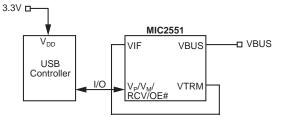


Figure 7. I/O Interface Using 3.3V

Signal Amplitude Respective to V_{IF}

When operating the MIC2551A, it is necessary to provide input signals which do not exceed V $_{\rm IF}$ + 0.3V.

Suspend

When the suspend pin (SUS) is high, power consumption is reduced to a minimum. V_{TRM} is not disabled. RCV, V_P and V_M are still functional to enable the device to detect USB activity. For minimal current consumption in suspend mode, it is recommended that OE# = 1, and SPD = 0.

Speed

The speed pin (SPD) sets D+/D- output edge rates by increasing or decreasing biasing current sources within the output drivers. For low speed, SPD = 0. For full speed, SPD = 1. By setting SPD = 0 during idle periods, in conjunction with suspend (SUS), the lowest quiescent current can be obtained. However, designers must provide a 300ns delay between changing SPD from 0 to 1 and transmission of data at full speed. This delay ensures the output drivers have arrived at their proper operating conditions. Failure to do so can result in leading edge distortion on the first few data bits transmitted.

External ESD Protection

The use of ESD transient protection devices is not required for operation, but is recommended. We recommend the following devices or the equivalent:

Cooper Electronic Technologies (www.cooperet.com)

41206ESDA SurgX[®] 0805ESDA SurgX[®]

Littelfuse (www.littelfuse.com)

V0402MHS05 SP0503BAHT

Non-Multiplexed Bus

In order to save pin count for the USB logic controller interface, the MIC2551A was designed with V_P and V_M as bidirectional pins. To interface the MIC2551A with a non-multiplexed data bus, resistors can be used for low cost isolation as shown in Figure 8.

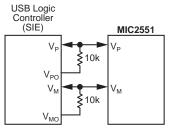


Figure 8. MIC2551A Interface to Non-Multiplexed Data Bus

| Configuration Mode | guration Mode VBUS/VTRM | | Notes | | |
|-------------------------------|-------------------------|---|---|--|--|
| Normal | Connected | Connected | Normal supply configuration and operation. | | |
| Disconnect (D+/D– sharing) | Open | OpenConnectedVP/VM are HIGH outputs, RCV is LOW. With OE# = 0 and SUS = 1, data lines may be driven wi external devices up to 3.6V. With D+, D– floating, I _{IF} draws less than 1μA. | | | |
| Disconnect | Ground | Connected | VP/VM are HIGH outputs, RCV is LOW. With D+, D– floating, I _{IF} draws less than 1µA. | | |
| Disable Mode | Connected | Open | Logic controlled inputs pins are Hi-Z. | | |
| Prohibited | Connected | Ground | Prohibited condition. | | |

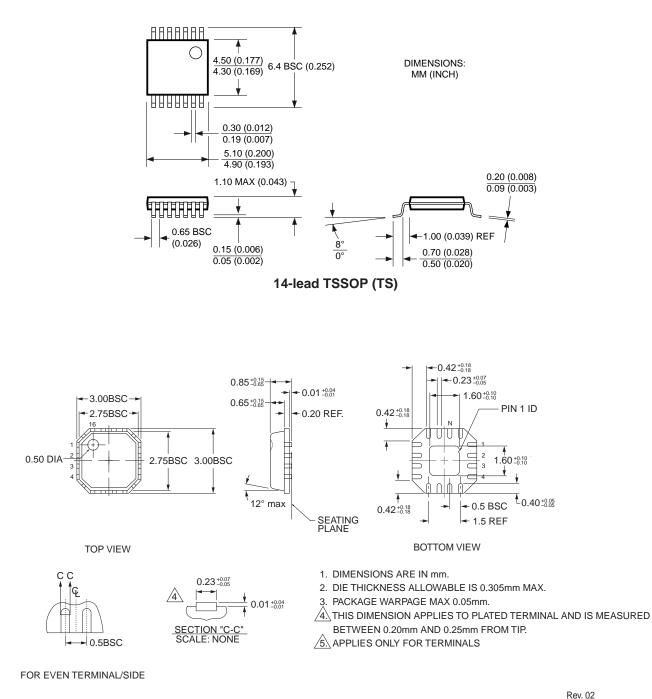
Table 3. Power Supply Configuration

PCB Layout Recommendations

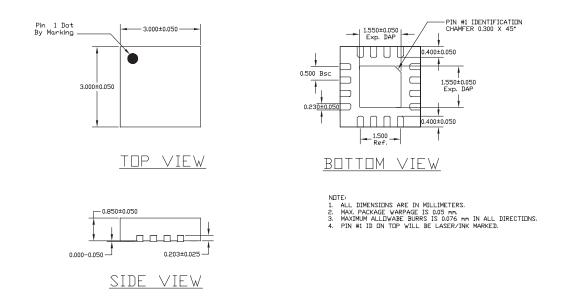
Although the USB standard and applications are not based in an impedance controlled environment, a properly designed PCB layout is recommended for optimal transceiver performance. The suggested PCB layout hints are as follows:

- Match signal line traces (VP/VM, D+, D–) to 40ps, approximately ¹/₃ inch if possible. FR-4 PCB material propagation is about 150ps/inch, so to minimize skew try to keep VP/VM, D+/D– traces as short as possible.
- For every signal line trace width (w), separate the signal lines by 1.5 2 widths. Place all other traces at >2 widths from all signal line traces.
- Maintain the same number of vias on each differential trace, keeping traces approximately at same separation distance along the line.
- Control signal line impedances to ±10%.
- Keep R_S as close to the IC as possible, with equal distance between R_S and the IC for both D+ and D-.

Package Information



16-Pin MLF[®] (ML)



16-Pin MLF[®] (ML)

MICREL INC. 2180 FORTUNE DRIVE SAN JOSE, CA 95131 USA

TEL + 1 (408) 944-0800 FAX + 1 (408) 474-1000 WEB http://www.micrel.com

This information furnished by Micrel in this data sheet is believed to be accurate and reliable. However no responsibility is assumed by Micrel for its use. Micrel reserves the right to change circuitry and specifications at any time without notification to the customer.

Micrel Products are not designed or authorized for use as components in life support appliances, devices or systems where malfunction of a product can reasonably be expected to result in personal injury. Life support devices or systems are devices or systems that (a) are intended for surgical implant into the body or (b) support or sustain life, and whose failure to perform can be reasonably expected to result in a significant injury to the user. A Purchaser's use or sale of Micrel Products for use in life support appliances, devices or systems is a Purchaser's own risk and Purchaser agrees to fully indemnify Micrel for any damages resulting from such use or sale.

© 2004 Micrel, Incorporated.

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for USB Interface IC category:

Click to view products by Microchip manufacturer:

Other Similar products are found below :

CY7C69356-48LTXC USB3319C-GJ-TR USB3370B-EZK-TR CYPD2120-24LQXI CYPD2122-20FNXIT CYPD2122-24LQXIT LIF-UC120-SWG36ITR50 UPD360-A/6HX CP2102NP1174GM DPO2039DABQ-13 CY7C68034-56LTXC TUSB212RWBT TUSB213IRGYT TUSB213RGYT USB3503T-I/ML CY7C63310-SXC USB3316C-CP-TR USB3250-ABZJ MAX3107ETG+ MAX14632EZK+T LAN9514-JZX CYPD2120-24LQXIT MAX3100CEE+T USB5806/KD USB5826-I/KD USB5826/KD USB5906/KD USB5916/KD USB5926/KD TUSB215QRGYTQ1 NB7NPQ701MMTTBG TUSB213RGYR USB5926-I/KD USB5906-I/KD USB4640I-HZH-03 CY7C63813-SXC CY7C63823-SXC CY7C64215-28PVXC CY7C68013A-128AXC CY7C68013A-56LTXI CY7C68013A-56PVXC CY7C68013A-56PVXI CYPD1120-40LQXI AP43771VDKZ-13 AP43771VFBZ-13 DIO32320MP10 HT42B534-2 FT2232HPQ-TRAY FT312D-32L1C-T KTU1001AEVA-TR